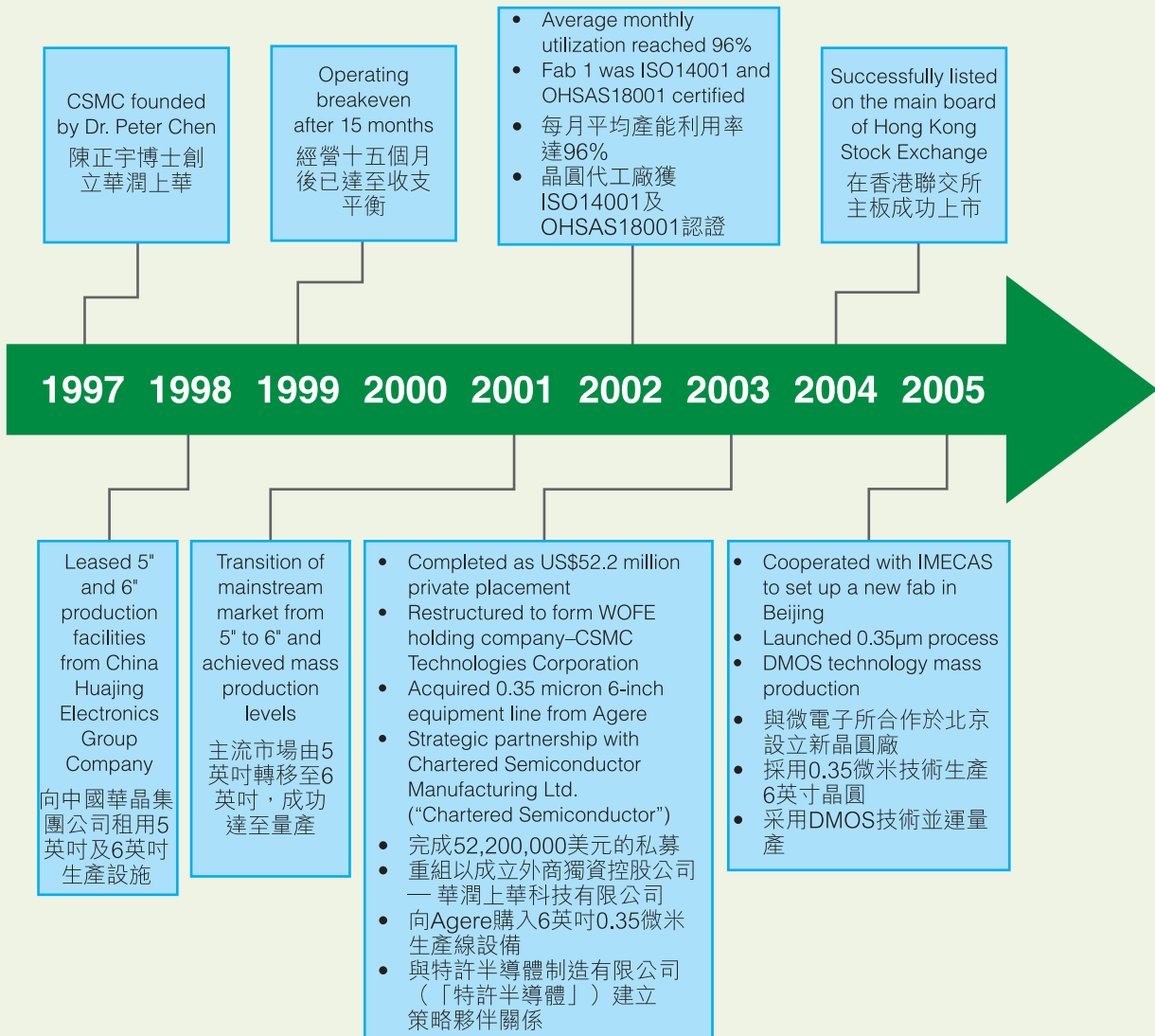


Historical Milestones 里程碑



To continuously explore the possibility of further expanding customer base and operational capacity, in October 2005, we signed a co-operation agreement with Institution of Microelectronics of the Chinese Academy of Science ("IMECAS") for certain premises, facilities, equipments, technologies and services in relation to the manufacturing of wafers. We will inject additional machinery and equipment, procure upgrades and improvement on the equipments provided by IMECAS and provide expertise and management to establish and operate a wholly owned entity (the "new fab") in Beijing with a capacity of 20,000 wafers per month. The new fab will commence operation in year 2006.

為持續開拓進一步擴大客戶群及產能的可能性，於二零零五年十月，本集團就有關製造晶圓之若干物業、廠房、設備、技術及服務與中國科學院微電子研究所（「微電子所」）簽署合作協議。本集團將會額外注入機器及設備，確保改善及提升微電子所提供的設備，並提供專業知識及管理團隊以在北京成立及經營一家全資公司（「新晶圓代工廠」），每月產能將達20,000片晶圓。新晶圓代工廠將會於二零零六年開始投產。